BGA Heat Sink (High Aspect Ratio Ext.) Standard Pin Fin



ATS Part#:

Description:



ATS043045006-PF030

Pin Fin

44.50 x 43.20 x 6.40 mm BGA Heat Sink (High Aspect Ratio Ext.) Standard Pin Fin

Heat Sink Type:	Standard
Heat Sink Attachment:	N/A
Equivalent Part Number:	N/A

*Image above is for illustration purpose only.

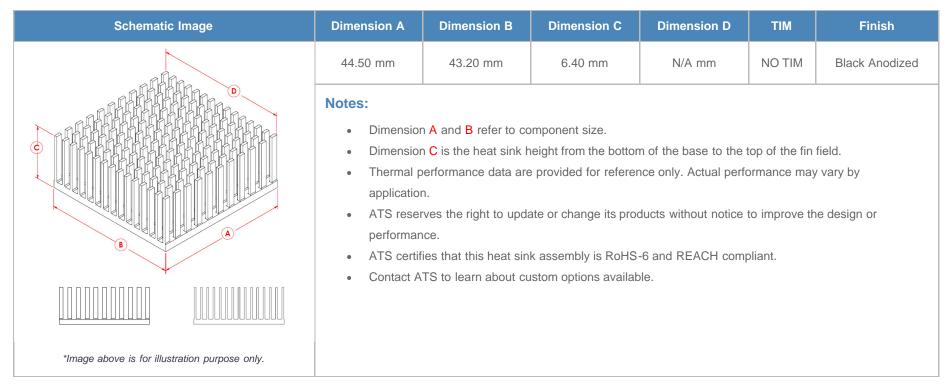
Features & Benefits

- Excellent balance of low cost and high performance in an aluminum heat sink. .
- Designed for semiconductor devices with omni-directional airflow requirements. .
- 11 x 10 pin array
- Available with a variety of thermal adhesive tape options. Contact sales@qats.com for product configurations.

Thermal Performance

AIR VELOCIT	Y	@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	9.4 °C/W	N/A °C/W					
	Ducted Flow	0	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail



For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.

